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BUT11F/11AF

High Voltage Power Switching Applications



NPN Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage		
020	: BUT11F	850	V
	: BUT11AF	1000	V
V _{CEO}	Collector-Emitter Voltage		
	: BUT11F	400	V
	: BUT11AF	450	V
V _{EBO}	Emitter-Base Voltage	9	V
I _C	Collector Current (DC)	5	Α
I _{CP}	*Collector Current (Pulse)	10	Α
I _B	Base Current (DC)	2	Α
I _{BP}	*Base Current (Pulse)	4	Α
P _C	Collector Dissipation (T _C =25°C)	40	W
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 65 ~ 150	°C

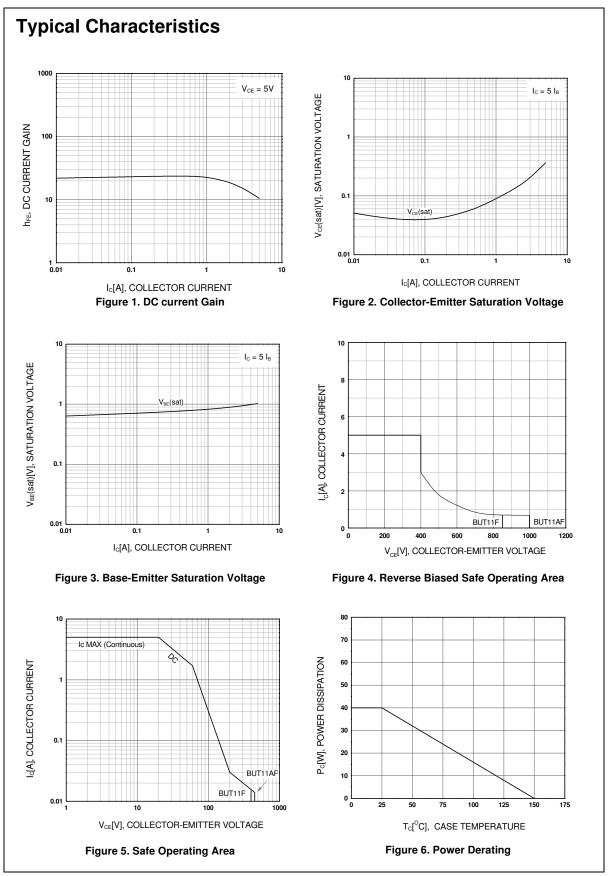
Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{CEO} (sus)	* Collector-Emitter Sustaining Voltage : BUT11F : BUT11AF	I _C = 100mA, I _B = 0	400 450			V V
I _{CES}	Collector Cut-off Current : BUT11F : BUT11AF	V _{CE} = 850V, V _{BE} = 0 V _{CE} = 1000V, V _{BE} = 0			1 1	mA mA
I _{EBO}	Emitter Cut-off Current	$V_{BE} = 9V, I_{C} = 0$			10	mA
V _{CE} (sat)	Collector-Emitter Saturation Voltage : BUT11F : BUT11AF	$I_C = 3A$, $I_B = 0.6A$ $I_C = 2.5A$, $I_B = 0.5A$			1.5 1.5	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage : BUT11F : BUT11AF	$I_C = 3A$, $I_B = 0.6A$ $I_C = 2.5A$, $I_B = 0.5A$			1.3 1.3	V V
t _{ON}	Turn On Time	$V_{CC} = 250V, I_{C} = 2.5A$			1	μs
t _{STG}	Storage Time	$I_{B1} = -I_{B2} = 0.5A$			4	μs
t _F	Fall Time	$R_L = 100\Omega$			0.8	μs

^{*} Pulsed: pulsed duration = 300μs, duty cycle = 1.5%

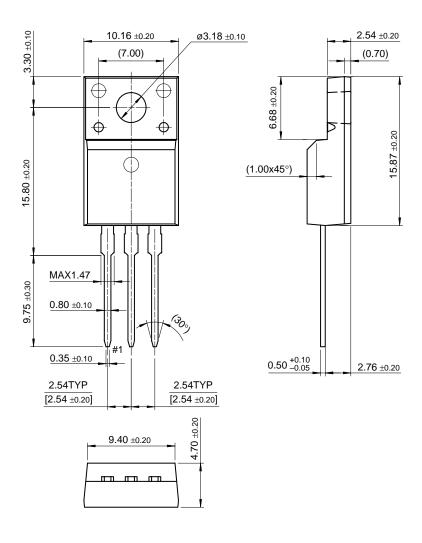
Thermal Characteristics $\rm T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Тур	Max	Units
$R_{\theta jC}$	Thermal Resistance, Junction to Case		3.125	°C/W



Package Demensions

TO-220F



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